

Shenzhen Aihui Technology Co. ,
Ltd.

Antenna test report

Test report

2026.03.30

(catalogue) :



(Model Information)

(Company profile)

(Passive and Matching)

(3D Active Test Data)



(Environmental treatment)

(Summary)



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1、 (Model Information)

Project name	3A1143	RF	
Model Name		LTE:	
Antenna Type		Band	
Model pictures :			

2、 (Passive and Matching)

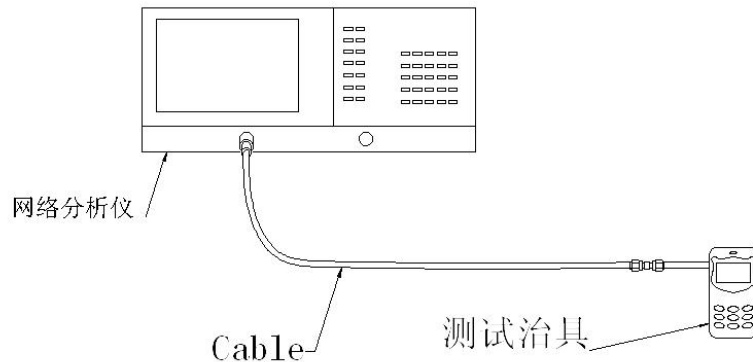
2.1A diagram of a passive test

S11 test method description

Testing equipment:

Network analyzer(E5071C 30k-8.5Ghz)

Test method: a 50 ohm CABLE is used to export from the instrument test port. After calibration, the sample machine and SMA joint of the instrument are connected.



2.2 Active test schematic

3D testing system: SHIELDED ANECHOIC chamber
testing environment: temperature 22 ° C ± 3 ° C, humidity 50% ± 15%
testing equipment: testing passive data, using the Network analyzer Agilent E5071C testing active data, using the synthesis instrument 8960cmw500

总全向辐射功率 (TIRP)

$$TIRP \equiv \frac{\pi}{2NM} \sum_{i=1}^{N-1} \sum_{j=0}^{M-1} [Eirp_{\theta}(\theta_i, \phi_j) + Eirp_{\phi}(\theta_i, \phi_j)] \sin(\theta_i)$$

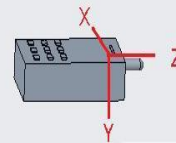
总全向辐射灵敏度 (TIRS)

$$TIRS \equiv \frac{2NM}{\pi \sum_{i=1}^{N-1} \sum_{j=0}^{M-1} \left[\frac{1}{EIS_{\theta}(\theta_i, \phi_j)} + \frac{1}{EIS_{\phi}(\theta_i, \phi_j)} \right]} \sin(\theta_i)$$

E1: XZ的切面 PHI=0

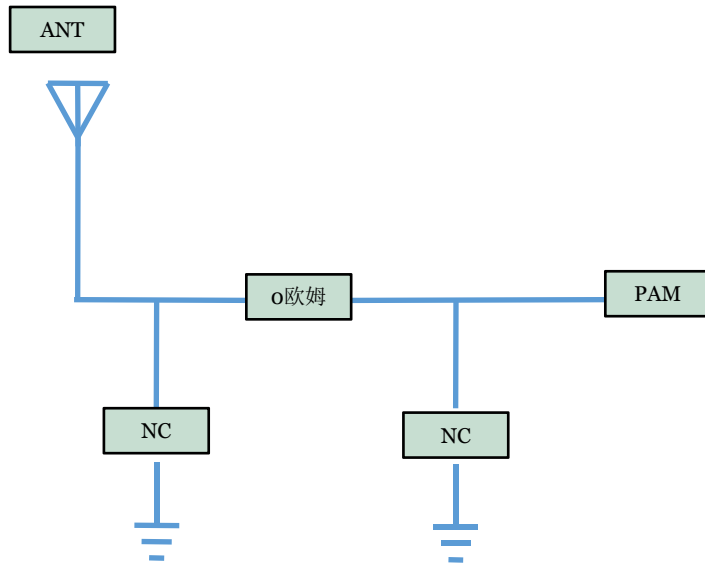
E2: YZ的切面 PHI=90

H: XY的切面 Theta=90



以喇叭天线为参考

2.3 (Matching Circuit)



Motherboard matching
has not changed.

Note: original string 0 ohm from
antenna string 0 ohm resistor pa



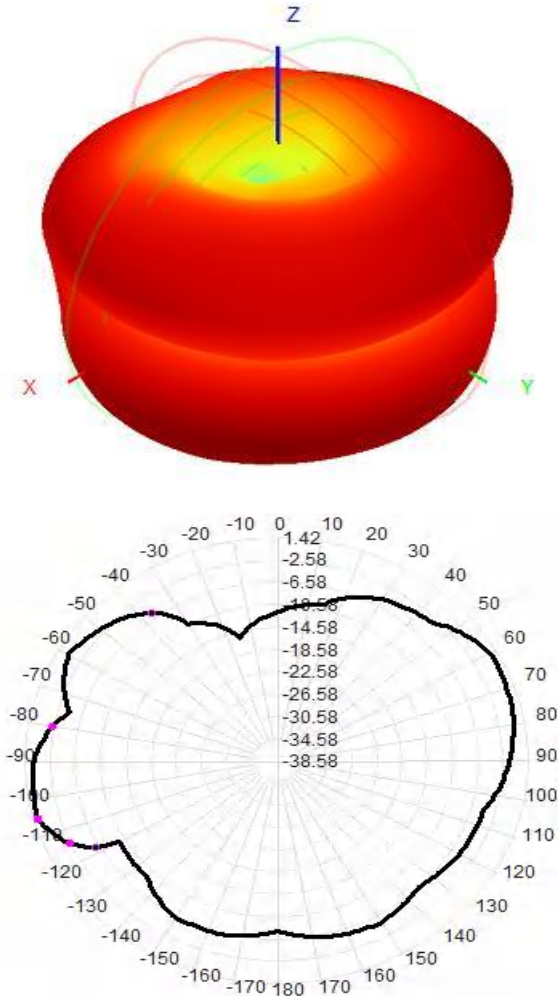
4.1 Antenna Active Test Data

Frequency Band	2.4GWIFI-B模			2.4WIFI-G模		
channel	L	M	H	L	M	H
TRP	13.63	13.44	13.52	12.63	12.44	12.41
TIS			-75.36			-68.62
Frequency Band	2.4WIFI-N模			5.8WIFI-A模		
channel	L	M	H	L	M	H
TRP	11.43	12.62	12.14	10.32	10.44	10.52
TIS			-66.96			-71.52

4.2 passive antenna test data

Test data:		
WIFI 2.4G		
Freq(MHz)	Efficiency (%)	Gain (dBi)
2400	52.11	1.16
2410	51.46	1.25
2420	56.35	1.33
2430	54.15	1.42
2440	53.60	1.06
2450	54.05	1.04
2460	52.69	1.11
2470	53.60	1.20
2480	51.84	1.06

4.2 passive antenna test data

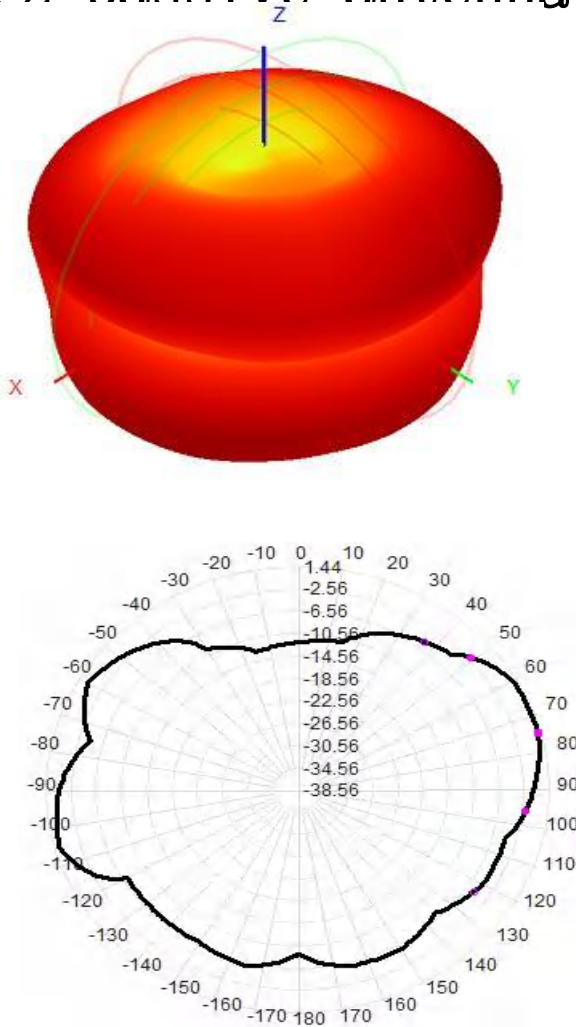


Test data:

WIFI 2.4G

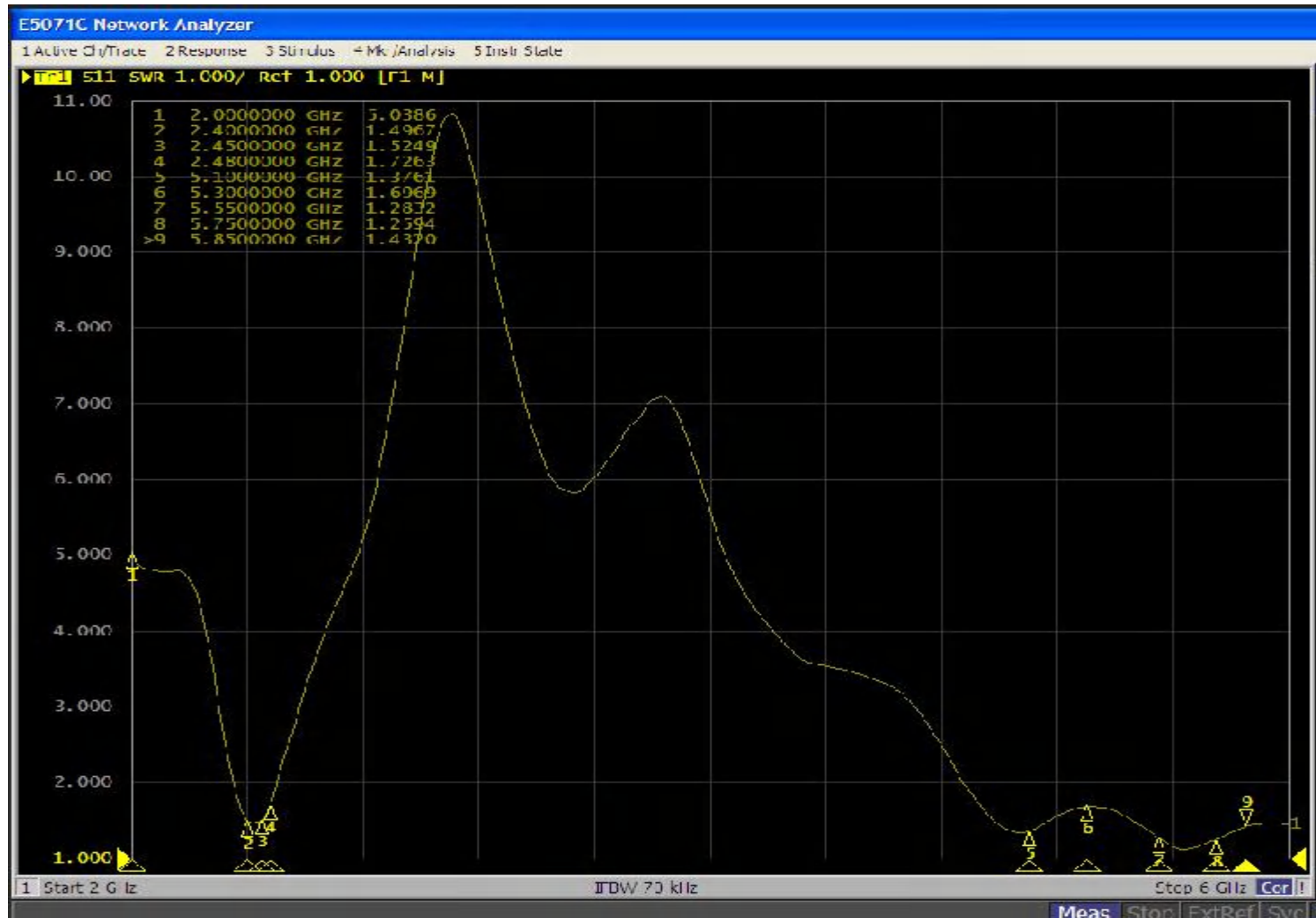
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2470	53.60	1.20
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4.2 passive antenna test data

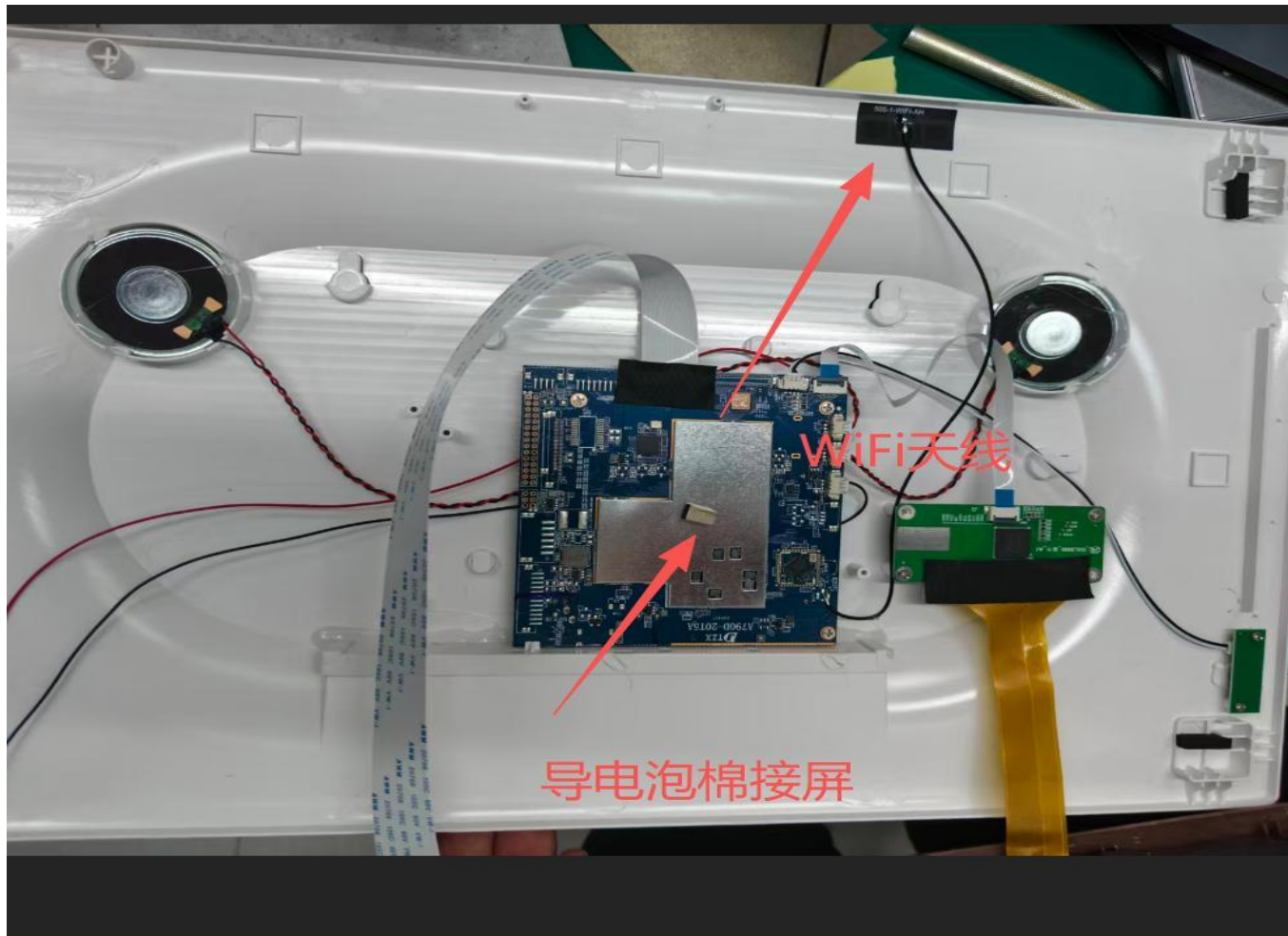


Test data:		
WIFI 5.8G		
Freq(MHz)	Efficiency (%)	Gain (dBi)
5000	52.64	1.06
5100	53.26	1.14
5200	54.19	1.25
5300	55.63	1.32
5400	51.16	1.44
5500	52.06	1.06
5600	54.92	1.10
5700	55.62	1.21
5800	54.16	1.03
5850	55.90	1.04

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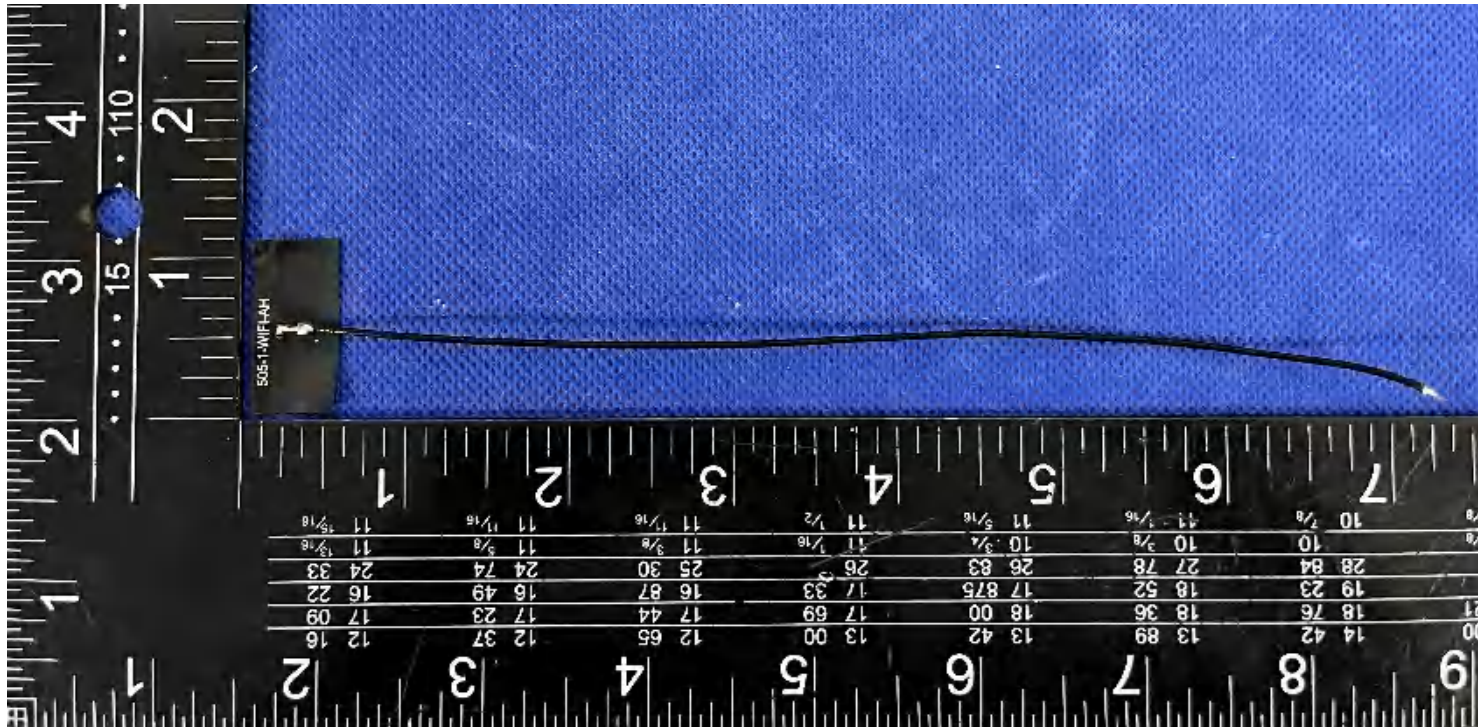


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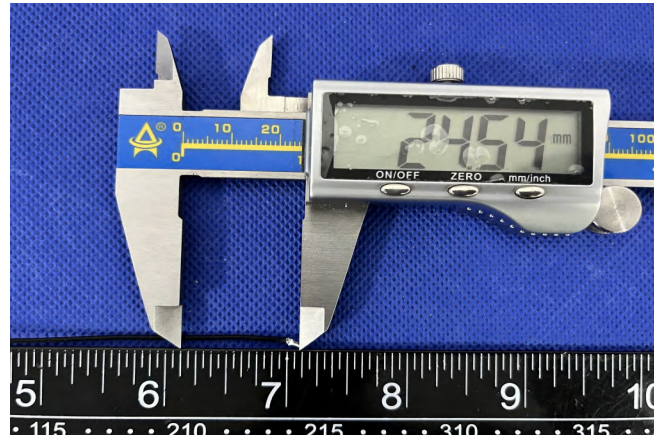
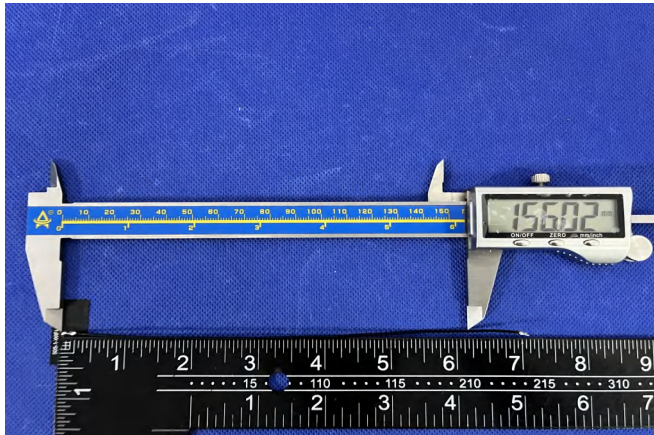
6、 (Antenna Dimensions)



Combined with the active, passive antenna, measured results, have reached the best state.

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(Antenna Dimensions)



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Note: 1. This report is based on the actual debugging and testing of the prototype, in which the environment processing, antenna position and the assembly position of each component can not be changed at will. 2. If there is any change in the materials used in the prototype, we need to make a timely feedback to revalidate. 3. List of sensitive devices: TP (material, coating, wiring, etc.) screen (amplifier circuit, LED, wiring design, etc.) shell material (antenna assembly mode, structural interference, shell material, antenna position height and area, etc.) motherboard (motherboard conduction, RF circuit matching, PA, dual-power, filter, LNA, power circuit, etc.) camera, battery, motor, MIC, fingerprint identification module, etc. 4. Because there are few or only one prototype, some probability problems can not be found out completely. It is suggested to check the problem points in small batch before mass production (such as flashing screen, loudspeaker noise, TP Jump Point, black screen death, signal diving, etc.)

Thank you

